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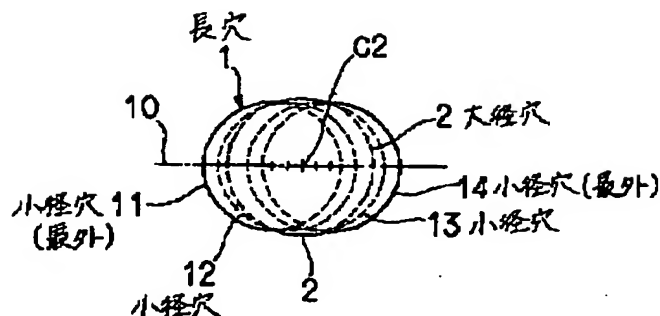
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APPLICANT : IBIDEN CO LTD;

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TITLE : PRINTED WIRING BOARD, AND ITS
BORING METHOD



ABSTRACT : PROBLEM TO BE SOLVED: To bore a specified size of slot which has a smooth inwall, easily and surely in the specified position.

SOLUTION: In a printed wiring board where a slot 1 is bored in an insulating board, the above slot 1 is made by boring a large-diameter hole 2 at the center position and two pieces each of small-diameter holes 11-14 at the right and left of this large-diameter hole 2. Moreover, the centers of the circles of the large-diameter hole 2 and the small-diameter holes 11-14 are arranged at regular intervals on the same axis, and besides the interval between the centers of the outermost small-diameter holes 11 and 14 positioned at the right and left outermost parts is smaller than the radii R of the small-diameter holes 11-14.

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